

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1093442	transparen\$4 clear see-through invisible penetrable	US-PGPUB; USPAT	OR	ON	2008/10/14 08:20
L2	3677614	substrate board chip base foundation wafer	US-PGPUB; USPAT	OR	ON	2008/10/14 08:20
L3	788695	I and L2	US-PGPUB; USPAT	OR	ON	2008/10/14 08:20
L4	15632	3 and "438".clas.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:21
L5	7734	4 and @pd < "20031217"	US-PGPUB; USPAT	OR	ON	2008/10/14 08:22
L6	15	5 and 438/456.ccls.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:24
L7	23664	1.ab.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:26
L8	14676	7 and 2	US-PGPUB; USPAT	OR	ON	2008/10/14 08:27
L9	10039	8 and @pd<"20031217"	US-PGPUB; USPAT	OR	ON	2008/10/14 08:27
L10	124	9 and "438".clas.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:28
L11	2021	I7 with l2	US-PGPUB; USPAT	OR	ON	2008/10/14 08:33
L12	3746	7 same 2	US-PGPUB; USPAT	OR	ON	2008/10/14 08:33
L13	73	11 and "438".clas.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:34
L14	42	13 and @pd<"20031217"	US-PGPUB; USPAT	OR	ON	2008/10/14 08:35
L15	1526467	transparen\$4 clear see-through invisible penetrable	US-PGPUB; USPAT	OR	ON	2008/10/14 08:49
L16	94290	15.ab.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:49
L17	20001	16 with 2	US-PGPUB; USPAT	OR	ON	2008/10/14 08:49
L18	1477	17 and "438".clas.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:50
L19	649	18 and @pd<"20031217"	US-PGPUB; USPAT	OR	ON	2008/10/14 08:50
L20	1	19 and 438/456.ccls.	US-PGPUB; USPAT	OR	ON	2008/10/14 08:51
S1	4	("20020117517" "6284113" "6375871" "6561208").PN.	US-PGPUB; USPAT	ADJ	ON	2008/10/02 09:10
S2	1742	(438/455).OCLS	US-PGPUB; USPAT	OR	OFF	2008/10/02 15:32
S3	1742	438/455.ccls.	US-PGPUB; USPAT	ADJ	ON	2008/10/02 15:33
S4	73	S3 and organic solvent	US-PGPUB; USPAT	ADJ	ON	2008/10/02 15:34
S5	68	S4 and @ad<"20060616"	US-PGPUB; USPAT	ADJ	ON	2008/10/02 15:35

S6	591	438/456	US PGPUB; USPAT	ADJ	ON	2008/10/02 15:41
S7	356	438/456.ccls.	US PGPUB; USPAT	ADJ	ON	2008/10/02 15:41
S8	0	438/456.clas.	US PGPUB; USPAT	ADJ	ON	2008/10/02 15:44
S9	356	438/456.ccls.	US PGPUB; USPAT	ADJ	ON	2008/10/02 15:44
S10	591	438/456	US PGPUB; USPAT	ADJ	ON	2008/10/02 15:45
S11	2870879	bond\$4 seal\$4 adher\$4 adhes\$4 coher\$4 stick cling cleave fast cohes\$4	US PGPUB; USPAT	OR	ON	2008/10/06 15:28
S12	3645043	substrate board chip base fondation wafer	US PGPUB; USPAT	OR	ON	2008/10/06 15:29
S13	431581	organic same solvent	US PGPUB; USPAT	OR	ON	2008/10/06 15:29
S14	466553	corona plasma	US PGPUB; USPAT	OR	ON	2008/10/06 15:29
S15	1379976	ketone (aromatic hydrocarbon) (cyanoacrylate compound) (halogenated hydrocarbon)	US PGPUB; USPAT	OR	ON	2008/10/06 15:30
S16	1322989	acetone chloroform (methylene chloride) ethylcyanoacrylate (carbon tetrachloride)	US PGPUB; USPAT	OR	ON	2008/10/06 15:32
S17	1325707	acetone chloroform (methylene chloride) ethylcyanoacrylate (carbon tetrachloride)	US PGPUB; USPAT	OR	ON	2008/10/06 15:33
S18	1115592	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/06 15:35
S19	3668706	substrate board chip base foundation wafer	US PGPUB; USPAT	OR	ON	2008/10/06 15:37
S20	1115738	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/06 15:39
S21	852565	S19 and S20	US PGPUB; USPAT	OR	ON	2008/10/06 15:39
S22	2570665	bond\$4 seal\$4 adher\$4 adhes\$4 stick cling cleave fasten cohes\$4 coher\$4	US PGPUB; USPAT	OR	ON	2008/10/06 15:40
S23	644501	S21 and S22	US PGPUB; USPAT	OR	ON	2008/10/06 15:41
S24	431581	organic same solvent	US PGPUB; USPAT	OR	ON	2008/10/06 15:41
S25	297929	(ketone (aromatic hydrocarbon) (cyanoacrylate compound) (halogenated hydrocarbon)) AND (organic NEAR solvent)	US PGPUB; USPAT	OR	ON	2008/10/06 15:44
S26	1323014	acetone chloroform (methylene chloride) ethylcyanoacrylate (carbon tetrachloride)	US PGPUB; USPAT	OR	ON	2008/10/06 15:46
S27	3668706	substrate board chip base foundation wafer	US PGPUB; USPAT	OR	ON	2008/10/06 15:54
S28	1115738	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/06 15:54
S29	852565	S27 and S28	US PGPUB; USPAT	OR	ON	2008/10/06 15:54
S30	2570665	bond\$4 seal\$4 adher\$4 adhes\$4 stick cling cleave fasten cohes\$4 coher\$4	US PGPUB; USPAT	OR	ON	2008/10/06 15:54

S31	644501	S29 and S30	US-PGPUB; USPAT	OR	ON	2008/10/06 15:54
S32	364411	S31 and @pd< "20031218"	US-PGPUB; USPAT	OR	ON	2008/10/06 15:54
S33	431581	organic same solvent	US-PGPUB; USPAT	OR	ON	2008/10/06 15:57
S34	466553	corona plasma	US-PGPUB; USPAT	OR	ON	2008/10/06 15:57
S35	89506	S33 and S34	US-PGPUB; USPAT	OR	ON	2008/10/06 15:59
S36	295072	(ketone (aromatic hydrocarbon) (cyanoacrylate compound) (halogenated hydrocarbon)) AND (organic adj solvent)	US-PGPUB; USPAT	OR	ON	2008/10/06 16:01
S37	320348	organic adj solvent	US-PGPUB; USPAT	OR	ON	2008/10/06 16:02
S38	2870879	bond\$4 seal\$4 adher\$ adhes\$ coher\$4 stick cling cleave fast cohes\$4	US-PGPUB; USPAT	OR	ON	2008/10/06 16:04
S39	3645043	substrate board chip base fondation wafer	US-PGPUB; USPAT	OR	ON	2008/10/06 16:04
S40	1951633	S38 and S39	US-PGPUB; USPAT	OR	ON	2008/10/06 16:04
S41	320348	organic adj solvent	US-PGPUB; USPAT	OR	ON	2008/10/06 16:06
S42	1115738	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate	US-PGPUB; USPAT	OR	ON	2008/10/06 16:06
S43	2516186	bond\$3 seal\$3 adher\$3 adhes\$3 stick cling cleave fasten coher\$3 cohes\$3	US-PGPUB; USPAT	OR	ON	2008/10/06 16:08
S44	3668706	substrate board chip base foundation wafer	US-PGPUB; USPAT	OR	ON	2008/10/06 16:08
S45	1714126	S43 and S44	US-PGPUB; USPAT	OR	ON	2008/10/06 16:09
S46	320348	organic adj solvent	US-PGPUB; USPAT	OR	ON	2008/10/06 16:09
S47	205876	S45 and S46	US-PGPUB; USPAT	OR	ON	2008/10/06 16:09
S48	466553	corona plasma	US-PGPUB; USPAT	OR	ON	2008/10/06 16:10
S49	54926	S47 and S48	US-PGPUB; USPAT	OR	ON	2008/10/06 16:10
S50	326212	ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon)	US-PGPUB; USPAT	OR	ON	2008/10/06 16:11
S51	25858	S49 and S50	US-PGPUB; USPAT	OR	ON	2008/10/06 16:11
S52	265165	acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride)	US-PGPUB; USPAT	OR	ON	2008/10/06 16:13
S53	410167	acetone chloroform (methylene adj chloride) ethylcyanoacrylate (carbon adj tetrachloride)	US-PGPUB; USPAT	OR	ON	2008/10/06 16:13
S54	18780	S51 and S53	US-PGPUB; USPAT	OR	ON	2008/10/06 16:13
S55	357663	polycarbonate polystyrene polypropylene (polyethylene adj derivativ\$3) polymethylmethacrylate	US-PGPUB; USPAT	OR	ON	2008/10/06 16:15
S56	10207	S55 and S54	US-PGPUB; USPAT	OR	ON	2008/10/06 16:15

S57	4296	S56 and @pd<"20031218"	US PGPUB; USPAT	OR	ON	2008/10/06 16:16
S58	28	S57 and "438".clas.	US PGPUB; USPAT	OR	ON	2008/10/06 16:18
S59	10207	S56 and pd<"20041217"	US PGPUB; USPAT	OR	ON	2008/10/06 16:26
S60	188	S59 and "438".clas.	US PGPUB; USPAT	OR	ON	2008/10/06 16:26
S61	2	((("6284113") or ("6375871")).PN.	US PGPUB; USPAT	OR	OFF	2008/10/07 09:57
S62	2834854	bond\$3 seal\$3 adher\$3 adhes\$3 coher\$3 stick cling cleave fasten cohes\$	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:07
S63	4879489	substrate board chip base foundation wafer	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:09
S64	758663	S62 and S63	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:09
S65	176233	polycarbonate polystyrene polypropylene (polyethylene adj derivative\$3) polymethylmethacrylate	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:11
S66	15570	S64 and S65	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:12
S67	177040	organic adj solvent	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:12
S68	123300	ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon)	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:13
S69	286258	S67 or S68	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:14
S70	101762	acetone chloroform (methylene adj chloride) ethylcyanacrylate (carbon adj tetrachloride)	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:15
S71	361404	S69 or S70	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:15
S72	2008	S66 and S71	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:16
S73	1041	S72 and @pd<"20031218"	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:17
S74	1186652	channel (fine adj channel) dissolve melt	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:24
S75	135	S73 and S74	EPO; JPO; DERWENT	OR	ON	2008/10/07 10:24
S76	1	("4962879").PN.	US PGPUB; USPAT	OR	OFF	2008/10/08 09:45
S77	2834854	bond\$3 seal\$3 adher\$3 adhes\$3 coher\$3 stick cling cleave fasten cohes\$	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:23
S78	4879489	substrate board chip base foundation wafer	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:23
S79	176233	polycarbonate polystyrene polypropylene (polyethylene adj derivative\$3) polymethylmethacrylate	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:23
S80	0	S77 and S78 and S79	US PGPUB; USPAT	ADJ	ON	2008/10/08 10:23
S81	0	S78 and S79	US PGPUB; USPAT	ADJ	ON	2008/10/08 10:24
S82	302035	S78 near("10") S79	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:25

S83	252452	S78 near("5") S79	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:26
S84	5010501	S78 near[5] S79	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:26
S85	3673777	S84 and @pd<"20031218"	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:27
S86	56693	S85 and "438".clas.	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:28
S87	9078	S86 and S77	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:29
S88	2	S87 and 438/459.ccls.	EPO; JPO; DERWENT	OR	ON	2008/10/08 10:33
S89	0	S78 and S79	US PGPUB; USPAT	OR	ON	2008/10/08 10:34
S90	0	S78 near[5] S79	US PGPUB; USPAT	OR	ON	2008/10/08 10:34
S91	0	S78 with S79	US PGPUB; USPAT	OR	ON	2008/10/08 10:35
S92	0	S78 same[3] S79	US PGPUB; USPAT	OR	ON	2008/10/08 10:35
S93	0	S78 adj S79	US PGPUB; USPAT	OR	ON	2008/10/08 10:37
S94	0	S79 and substrate	US PGPUB; USPAT	OR	ON	2008/10/08 10:37
S95	3647500	substrate board chip base fondation wafer	US PGPUB; USPAT	OR	ON	2008/10/08 10:39
S96	1116351	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/08 10:39
S97	848342	S95 and S96	US PGPUB; USPAT	OR	ON	2008/10/08 10:39
S98	1116351	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/08 10:41
S99	848342	S98 and S95	US PGPUB; USPAT	OR	ON	2008/10/08 10:41
S100	3671174	substrate board chip base foundation wafer	US PGPUB; USPAT	OR	ON	2008/10/08 10:43
S101	1116351	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/08 10:44
S102	853078	S100 and S101	US PGPUB; USPAT	ADJ	ON	2008/10/08 10:44
S103	1116351	S101 and S101	US PGPUB; USPAT	ADJ	ON	2008/10/08 10:45
S104	18	S103 and 438/456.ccls.	US PGPUB; USPAT	ADJ	ON	2008/10/08 10:46
S105	18	S104 and @py<"20031218"	US PGPUB; USPAT	ADJ	ON	2008/10/08 10:47
S106	853078	S100 and S101	US PGPUB; USPAT	ADJ	ON	2008/10/08 11:11
S107	3671174	substrate board chip base foundation wafer	US PGPUB; USPAT	OR	ON	2008/10/08 11:13
S108	1116351	polycarbonate polystyrene polypropylene (polyethylene derivativ\$3) polymethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/08 11:13

S109	853078	S107 and S108	US PGPUB; USPAT	ADJ	ON	2008/10/08 11:13
S110	498775	S109 and @pd<"20031218"	US PGPUB; USPAT	ADJ	ON	2008/10/08 11:13
S111	3122	S110 and "438".clas.	US PGPUB; USPAT	ADJ	ON	2008/10/08 11:14
S112	31	S111 and 438/455.cds.	US PGPUB; USPAT	ADJ	ON	2008/10/08 11:16
S113	146185	corona\$4	US PGPUB; USPAT	OR	ON	2008/10/08 15:58
S114	1	"20070141805".pn.	US PGPUB; USPAT	OR	ON	2008/10/08 15:59
S115	1	S113 and S114	US PGPUB; USPAT	OR	ON	2008/10/08 15:59
S116	935202	solvent ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon) acetone chloroform (methylene adj chloride) ethicyanoacrylate (carbon adj tetrachloride)	US PGPUB; USPAT	OR	ON	2008/10/09 10:51
S117	1446623	plastic polycarbonate polystyrene polypropylene (polyethylene adj derivativ\$3) polymethylmethacrylate	US PGPUB; USPAT	OR	ON	2008/10/09 10:53
S118	21974	S117 and "3" with (corona\$4 or plasma)	US PGPUB; USPAT	OR	ON	2008/10/09 10:54
S119	326	S117 and S116 with (corona\$4 and plasma)	US PGPUB; USPAT	OR	ON	2008/10/09 10:55
S120	326	S119 and @py<"20031217"	US PGPUB; USPAT	OR	ON	2008/10/09 10:57
S121	138	S119 and @pd<"20031217"	US PGPUB; USPAT	OR	ON	2008/10/09 10:58
S122	1	S121 not solvent	US PGPUB; USPAT	OR	ON	2008/10/09 11:35
S123	551495	ketone (aromatic adj hydrocarbon) (cyanoacrylate adj compound) (halogenated adj hydrocarbon) acetone chloroform (methylene adj chloride) ethicyanoacrylate (carbon adj tetrachloride)	US PGPUB; USPAT	OR	ON	2008/10/09 11:35
S124	1259	S117 and S123 with (corona\$4 or plasma)	US PGPUB; USPAT	OR	ON	2008/10/09 11:36
S125	652	S124 and @pd<"20031217"	US PGPUB; USPAT	OR	ON	2008/10/09 11:37
S126	20	S125 and "438".clas.	US PGPUB; USPAT	OR	ON	2008/10/09 11:37
S127	1	("6425972").PN.	US PGPUB; USPAT	OR	OFF	2008/10/10 11:13

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